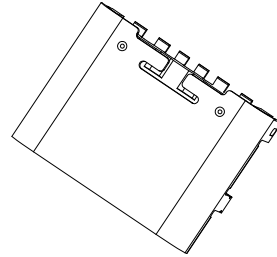
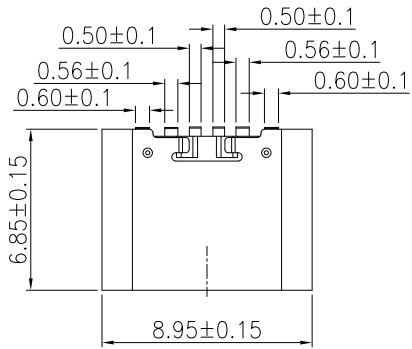


1 2 3 4 5 6 7 8 9 10

A



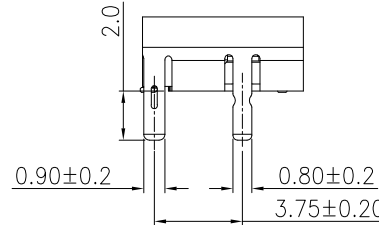
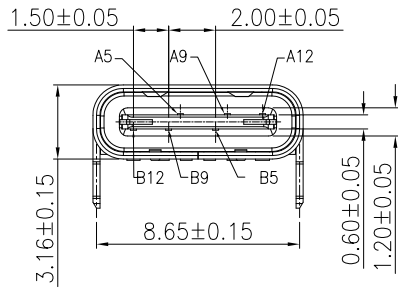
3D VIEW

NOTES:

- 1.MATERIAL:
 - MOLDING: HIGH TEMPERATURE UL94 V-0.
 - CONTACT:COPPER ALLOY.
 - GOLD PLATED Min ON CONTACT AREA,100u''
 - Min TIN (LEAD FREE) ON SOLDER AREA,
 - SHELL: SUS
 - 50u'' NICKEL PLATING OVER ALL.
- 2.MECHANICAL:
 - INSERTION: 5~20N.
 - EXTRACTION: 8~20N AFTER TEST.
- 3.ELECTRICAL:
 - CURRENT: 3A FOR VBUS;
 - 1.25A FOR GND PIN.
 - 0.25A FOR OTHER.
 - VOLTAGE: 20 V MAX
 - WITHSTANDING VOLTAGE: 100V AC R.M.S.
 - CONTACT RESISTANCE: 40mΩ MAX.
 - INSULATION RESISTANCE: 100MΩ MIN.
- 4.ENVIRONMENTAL
 - TEMPERATURE RANGE -25°C ~ +85°C

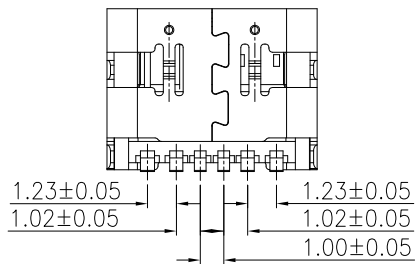
B

C

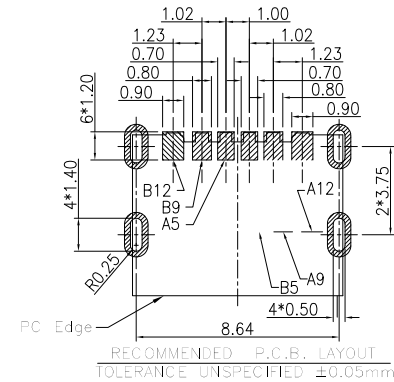


D

E


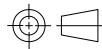


B12	GND
B9	VBUS
B5	CC2
A5	CC1
A9	VBUS
A12	GND
PIN	SIGNAL NAME



PROPRIETARY NOTE:

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.X ±0.30	APPROVED:	 http://www.rego.com.tw
.XX ±0.20	CHECKED:	
.XXX±0.15	DRAWN:	
X* ± 3*		
	UNITS:	SCALE:
	mm	NONE
		PART NO: 9177USB31-F00602
		SHEET: 1 OF 1

F

A	14.1.2022
REV	DATE

1 2 3 4 5 6 7 8 9 10